

SEM TD & Committee Meeting Schedule

Participate in SEM Technical Divisions Get the Most out of Your Membership

The SEM Technical Divisions are grass-roots building blocks of the Society for Experimental Mechanics. These divisions meet formally and informally at various Society events, address current practices and prepare action plans for communicating the activities in their technical area to the rest of the Society, and to groups outside the Society. This is very often accomplished by organization of technical sessions at SEM Conferences. Many of the SEM Technical Divisions have had a significant impact on SEM Conference Programs on a regular basis, i.e. Electronic Packaging, Composite Materials, Technical Committee on Strain Gages at the SEM Annual Conferences and Modal Analysis/Dynamic Systems at IMAC — A Conference and Exposition on Structural Dynamics.

Please plan to attend the Technical Committee Meetings scheduled at the 2010 SEM Annual Conference. Refer to the list below to determine which Technical Division you may be interested in and then check the schedule for meeting time and location.

Technical Activities Council:

P.G. Ifju, *Chair*; F. Pierron, *V. Chair*; G.C. Foss

Applied Photoelasticity:

T. Chen, *Chair*

Biological Systems and Materials:

K.J. Grande-Allen, *Chair*; B. Prorok, *V. Chair*; F. Barthelat, *Secretary*

Civil Structures Testing:

R. Bolton, *Chair*; P. Reynolds, *V. Chair*; J. Caicedo, *Secretary*;
Á. Cunha, *Past Chair*

Composite Materials:

A.K. Ghosh, *Chair*; G.P. Tandon, *V. Chair*; C.S. Korach, *Secretary*

Dynamic Behavior of Materials:

K.A. Danneman, *Chair*; V. Chalivendra, *V. Chair*; B. Song, *Secretary*

Electronic Packaging:

P. Lall, *Chair*; Z. Wang, *V. Chair*; W.C. Ralph, *Secretary*

Fracture and Fatigue:

R.P. Singh, *Chair*; M.N. Cavalli, *V. Chair*; S. Daly, *Secretary*

Inverse Problem Methodologies:

H. Sol, *Chair*; K. Genovese, *V. Chair*; J. Considine, *Secretary*

MEMS and Nanotechnology:

C. Furlong, *Chair*; G. Shaw, *V. Chair*; B. Prorok, *Secretary*

Modal Analysis/Dynamic Systems:

C.D. Van Karsen, *Chair*; J.P. DeClerck, *V. Chair*

Model Validation and Uncertainty Quantification:

T.W. Simmermacher, *Chair*; R. Mayes, *V. Chair*; S. Atamturktur, *Secretary*;
M. Allen, *Historian*

Optical Methods:

A. Voloshin, *Chair*; K. Genovese, *V. Chair*; H. Jin, *Secretary*

Residual Stress:

G.S. Schajer, *Chair*; G. Horn, *Secretary*

Sensors & Instrumentation:

G.C. Foss, *Chair*; P. Walter, *V. Chair*; M. Todd, *Secretary*;
M. Yu, *Ann. Mtg. Prog. Chair*

Structural Testing/Lightweight Structures:

V. Kulkarni, *Chair*; H. Sadid, *V. Chair*; J. Rakow, *Secretary*

Technical Committee on Strain Gages (TCSG):

V. Whnuk, *Chair*; R. Watson, *V. Chair*; R. Showalter, *Secretary*

Thermal Methods:

R.J. Greene, *Chair*; D. Backman, *V. Chair*

Time Dependent Materials:

R.B. Hall, *Chair*; H.J. Qi, *V. Chair*

Western Regional Strain Gage Committee (WRSG):

H. Boller, *Chair*; D. Peterson, *V. Chair*; B. Donnelly, *Secretary*

Applications Committee:

R.M. French, *Chair*

Education Committee:

J.D. Helm, *Chair*; K. Toohey, *V. Chair*

Research Committee:

I. Chasiotis, *Chair*; R.P. Singh, *V. Chair*; E.N. Brown, *Secretary*

SEM TD & Committee Meeting Schedule

All members and attendees at the 2010 SEM Conference are invited to attend any of the following meetings *except* those designated by an asterisk (*).

Sunday

9:30 AM	*Nominating	Erie
11:00 AM	SEMEF	Erie
1:00 PM	Finance	Executive Board Rm.
6:30 PM	Annual Business Meeting	C&O
7:30 PM	Welcome Reception	Grand Hall

Monday

10:30 AM	2011 Track/Symposia Organizers	Southern♦
	♦Cancelled	
11:00 AM	Research Committee	Erie
1:30 PM	EM International Advisory Board	Southern
3:30 PM	EM Papers Review Committee	Southern
4:10 PM	Pre-Technical Activities Council	Erie

Tuesday

10:30 AM	Education Committee	Southern
10:30 AM	*Honors Committee	Erie
12:10 PM	ALL TECHNICAL DIVISIONS MEET	
	Biological Systems & Materials	Nickel Plate
	Composite Materials	New York Central
	Dynamic Behavior of Materials	Wabash
	Electronic Packaging	C&O
	Fracture & Fatigue	Southern
	Inverse Problem Methodologies	Grand Hall Alcove S.E.
	MEMS & Nanotechnology	C&O
	Optical Methods & Applied Photoelasticity	Erie
	Residual Stress	B&O
	Structural Testing	Grand Hall Alcove S.E.
	TCSG	Grand Hall Alcove S.E.
	Thermal Methods	Grand Hall Alcove S.E.
	Time Dependent Materials	Milwaukee
1:30 PM	ET Advisory Group	Southern
3:30 PM	ET Editorial Group	Southern
5:30 PM	*Fellows	Southern♦
	♦Moved from Wednesday	
6:30 PM	President's Reception	Grand Hall

Wednesday

9:00 AM	Applications Committee	Southern
12:30 PM	All Society Awards Luncheon	Grand Hall
3:10 PM	Technical Activities Council	Southern
6:30 PM	Easley Winery Tour & Dinner	Meet in hotel Lobby

Thursday

9:00 AM	National Meetings Council	Southern
10:30 AM	Editorial Council	Southern
1:00 PM	Executive Board Meeting	Southern